

Solid State Relay OCMOS FET

PS7241-1A

4-PIN SOP 400 V BREAK DOWN VOLTAGE 1-ch Optical Coupled MOS FET

DESCRIPTION

The PS7241-1A is a solid state relay containing GaAs LEDs on the light emitting side (input side) and normally open (N.O.) contact MOS FETs on the output side.

It is suitable for analog signal control because of its low offset and high linearity.

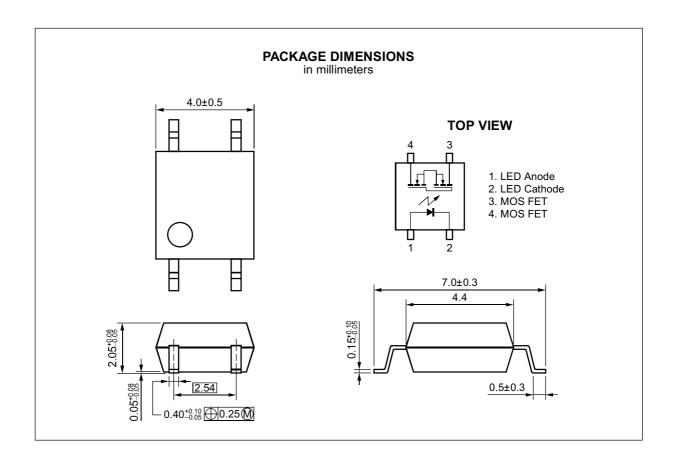
FEATURES

- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- · Low offset voltage
- · Ordering number of taping product: PS7241-1A-E3, E4, E5, F3, F4
- UL approved: File No. E72422 (S)
- BSI approved: No. 8241/8242
- · CSA approved: No. CA 101391
- VDE approved: No. 121302 ÜG

APPLICATIONS

- · Laptop PC, PDA
- Modem card
- · Telephone, FAX
- · Measurement equipment

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ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number*1
PS7241-1A	4-pin SOP	Magazine case 100 pcs	PS7241-1A
PS7241-1A-E3		Embossed Tape 900 pcs/reel	
PS7241-1A-E4			
PS7241-1A-E5		Embossed Tape 1 000 pcs/reel	
PS7241-1A-F3		Embossed Tape 3 500 pcs/reel	
PS7241-1A-F4			

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation	Po	50	mW
	Peak Forward Current [™]	IFP	1	Α
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	Iι	120	mA
	Pulse Load Current ² (AC/DC Connection)	ILP	240	mA
	Power Dissipation	Po	300	mW
Isolation Voltage *3		BV	1 500	Vr.m.s.
Total Power Dissipation		Рт	350	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		T _{stg}	-40 to +100	°C

^{*1} PW = 100 μ s, Duty Cycle = 1 %

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^{*2} PW = 100 ms, 1 shot

^{*3} AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

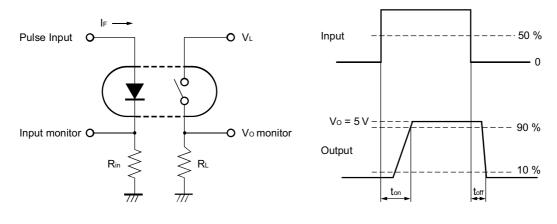
RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

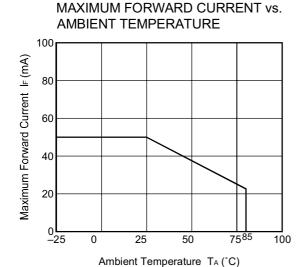
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	lr	V _R = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	VD = 400 V		0.03	1.0	μΑ
	Output Capacitance	Cout	V _D = 0 V, f = 1 MHz		54		pF
Coupled	LED On-state Current	Fon	IL = 120 mA			2.0	mA
	On-state Resistance	Ron1	I _F = 10 mA, I _L = 10 mA		18	30	Ω
		Ron2	IF = 10 mA, IL = 120 mA, t ≤ 10 ms		15	25	
	Turn-on Time ^{*1}	ton	I_F = 10 mA, Vo = 5 V, R _L = 500 Ω,		0.5	2.0	ms
	Turn-off Time*1	t off	PW ≥ 10 ms		0.07	0.2	
	Isolation Resistance	R _{I-0}	V _{I-O} = 1.0 kV _{DC}	10°	·		Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.5		pF

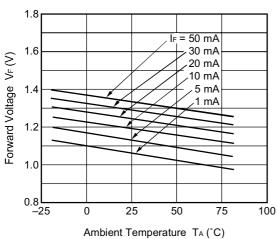
*1 Test Circuit for Switching Time



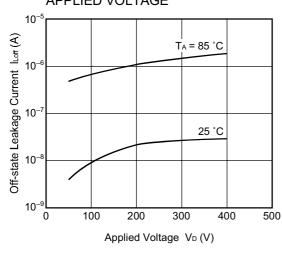
★ TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)



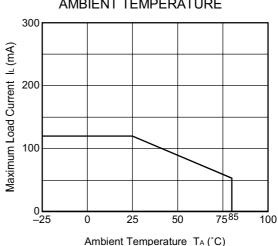




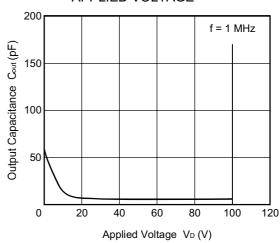
OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE



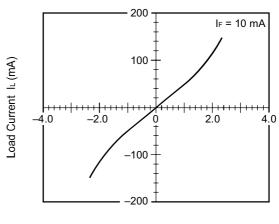
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



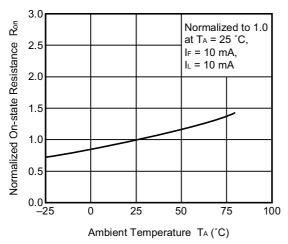
LOAD CURRENT vs. LOAD VOLTAGE



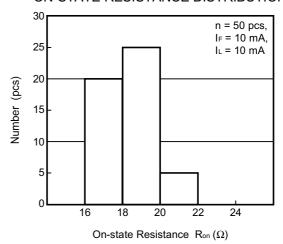
Load Voltage V_L (V)



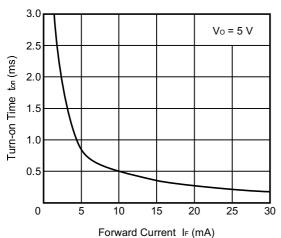
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



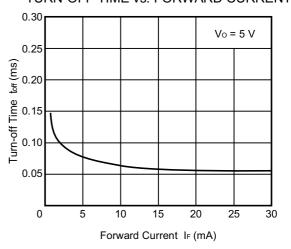
ON-STATE RESISTANCE DISTRIBUTION



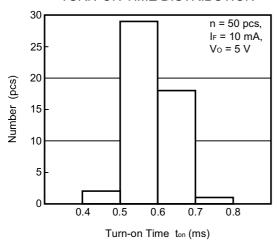
TURN-ON TIME vs. FORWARD CURRENT



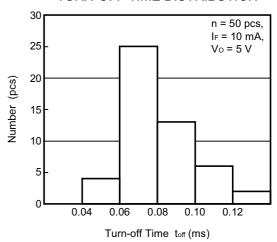
TURN-OFF TIME vs. FORWARD CURRENT



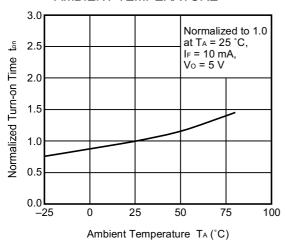
TURN-ON TIME DISTRIBUTION



TURN-OFF TIME DISTRIBUTION

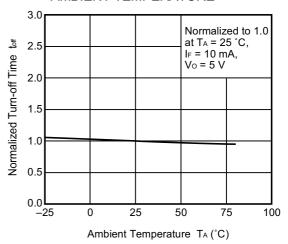


NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

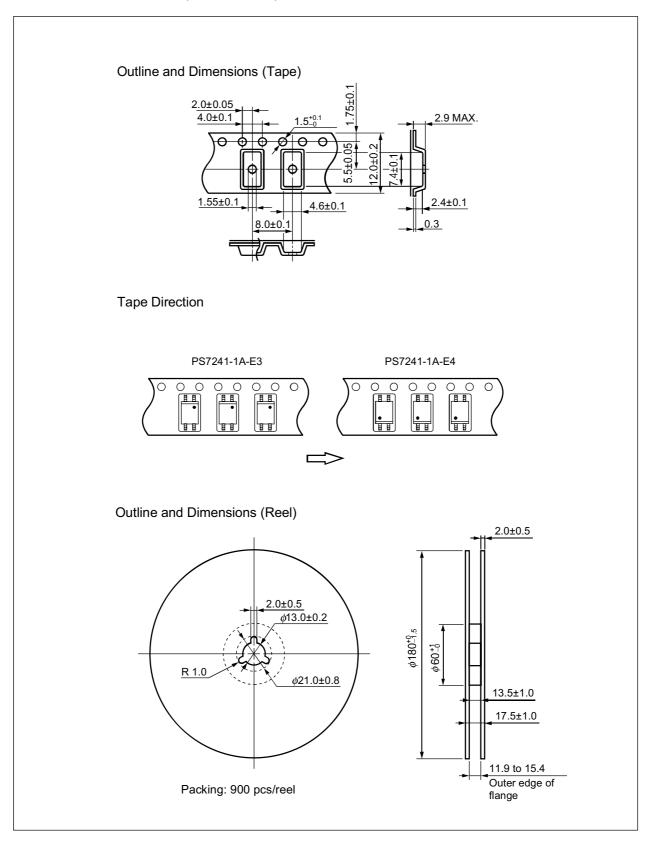


Remark The graphs indicate nominal characteristics.

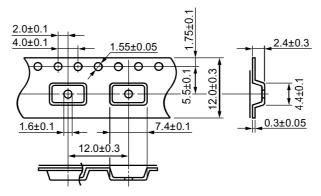
NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



★ TAPING SPECIFICATIONS (in millimeters)

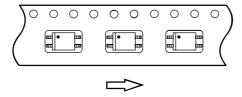


Outline and Dimensions (Tape)

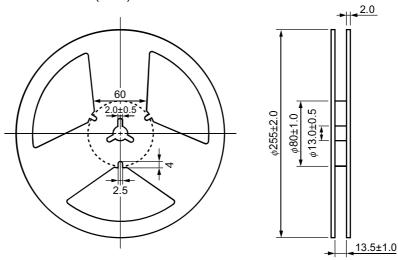


Tape Direction

PS7241-1A-E5

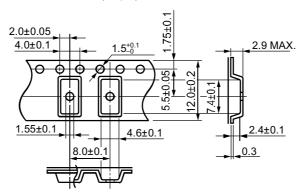


Outline and Dimensions (Reel)

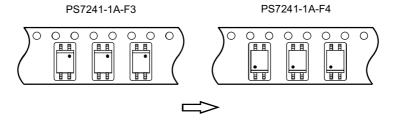


Packing: 1 000 pcs/reel

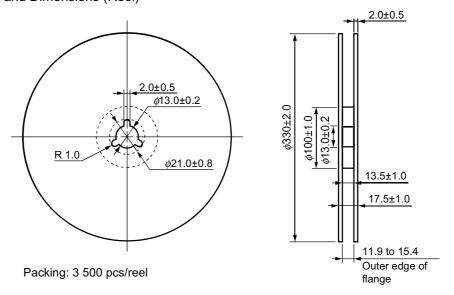
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)





RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

· Peak reflow temperature 260°C or below (package surface temperature)

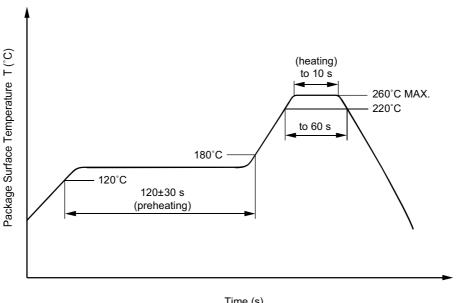
· Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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M8E 00.4-0110



SAFETY INFORMATION ON THIS PRODUCT

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GaAs Products

The product contains gallium arsenide, GaAs.

GaAs vapor and powder are hazardous to human health if inhaled or ingested.

- · Do not destroy or burn the product.
- Do not cut or cleave off any part of the product.
- · Do not crush or chemically dissolve the product.
- Do not put the product in the mouth.

Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

▶For further information, please contact

NEC Compound Semiconductor Devices, Ltd.

5th Sales Group, Sales Division TEL: +81-44-435-1588 FAX: +81-44-435-1579 E-mail: salesinfo@csd-nec.com

NEC Compound Semiconductor Devices Hong Kong Limited

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309 Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH http://www.ee.nec.de/

TEL: +49-211-6503-01 FAX: +49-211-6503-487

California Eastern Laboratories, Inc. http://www.cel.com/

TEL: +1-408-988-3500 FAX: +1-408-988-0279